

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT5242875

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	MICHAEL ZENOU	02/23/2017
	ZVI KOTLER	02/23/2017
RECEIVING PARTY DATA		
Name:	ORBOTECH LTD.	
Street Address:	P.O. BOX 215	
City:	YAVNE	
State/Country:	ISRAEL	
Postal Code:	8110101	
PROPERTY NUMBERS Total: 1		
	Property Type	Number
	Application Number:	16194407
CORRESPONDENCE DATA		
Fax Number:	(003)562-2297	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
Phone:	97235622291	
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Correspondent Name:	D. KLIGLER I.P. SERVICES LTD	
Address Line 1:	P.O. BOX 57651	
Address Line 4:	TEL AVIV, ISRAEL 61576	
ATTORNEY DOCKET NUMBER:	1027-1017.2	
NAME OF SUBMITTER:	SVETLANA RUDNIK	
SIGNATURE:	/Svetlana Rudnik/	
DATE SIGNED:	11/19/2018	
	This document serves as an Oath/Declaration (37 CFR 1.63).	
Total Attachments: 4		
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DECLARATION AND ASSIGNMENT

AS A BELOW NAMED INVENTOR, I hereby declare that:

This declaration and assignment are directed to the patent application, entitled LIFT PRINTING OF CONDUCTIVE TRACES ONTO A SEMICONDUCTOR SUBSTRATE, which was filed as a PCT Application PCT/IL2015/000046, on October 19, 2015 (hereinafter, the Application).

The above-identified Application was made or authorized to be made by me.

I believe I am the original inventor or an original joint inventor of a claimed invention in the Application.

I hereby acknowledge that any willful false statement made in the above declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

In consideration of the sum of one dollar (\$1.00) and other good and valuable consideration paid to me, the receipt and sufficiency of which are hereby acknowledged, I agree to assign, and hereby do assign, to:

ORBOTECH LTD., an Israeli company, having a place of business at P.O. Box 215, Yavne 8110101, Israel (hereinafter, Assignee),

my entire right, title and interest in and to any and all inventions described and/or claimed in the Application (hereinafter, the Invention), including, without limitation, the above-mentioned Application itself and all other provisional and non-provisional applications deriving from the above-mentioned Application, and including any original and/or reissued Letters Patent of the United States granted for the Invention and any divisions, reissues, continuations, continuations-in-part, and extensions of any such patent application(s), and including any patents or other forms of protection of industrial property that may be granted in relation to the Invention in any other country, and including the rights to file and prosecute all applications for patents and other forms of protection of industrial property in the United States and other countries and to claim priority from the above-mentioned Application in the United States and in any other country, and including the subject matter of any and all claims which may be obtained in such patents and the right to enforce such patents.

I hereby authorize and request the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from the above-mentioned Application and any divisions, reissues, continuations, or continuations-in-part thereof to the Assignee, as Assignee of the entire interest, and likewise authorize officials of other countries to issue patents and other forms of industrial property protection to the Assignee.

I hereby covenant that I have full right to convey the entire interest herein assigned, and that I have not executed and will not execute any agreement in conflict herewith.

I agree to execute all papers in connection with the above-mentioned Application and any applications filed as divisions, reissues, continuations, or continuations-in-part thereof or otherwise deriving from the above-mentioned Application, including separate assignments in connection with

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such applications, that the Assignee may deem desirable for the purposes of obtaining, protecting and enforcing its rights in the Invention.

I agree to communicate to the Assignee or representatives thereof any facts known to me respecting the Invention and improvements thereof, and will, upon request, but without expense to myself, testify in any legal proceedings regarding the invention and provide any other assistance deemed necessary by the Assignee to obtain, protect and enforce its rights in the Invention.

This Assignment shall be binding upon the heirs, executors, administrators, and assigns of each of the Inventors listed below, and shall inure to the benefit of the heirs, executors, administrators, successors and assigns of the Assignee.

IN WITNESS WHEREOF, the Inventors have executed this Assignment on the date or dates indicated below:

First inventor: Michael Zenou, citizen of Israel

Inventor signature:  Date: 23 February 2017

Residence: 17 Halevona Street, Hashmonaim 7312700, Israel

Second inventor: Zvi Kotler, citizen of Israel

Inventor signature: _____ Date: _____

Residence: 14 Feibel Street, Tel Aviv 6299516, Israel

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